P40B10SN

Power MOSFETs 100V, 40A, N-channel

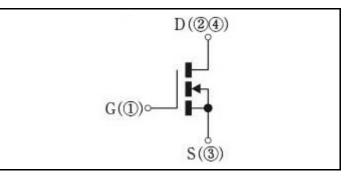
Feature

- N-channel
- SMD
- Low Ron
- 10V Gate Drive
- Low Capacitance
- Pb free terminal
- · RoHS:Yes

OUTLINE



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 150	°C
Channel tempertature	Tch		-55 to 150	°C
Drain-source voltage	V _{DSS}		100	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	I _D		40	А
Continuous drain current(Peak)	I _{DP}	Pulse width 10µs, duty=1/100	120	А
Total power dissipation	P _T		62.5	W
Single avalanche current	I _{AS}	Starting Tch=25°C Tch≦150°C	28	А
Single avalanche energy	E _{AS}	Starting Tch=25°C Tch≦150°C	88	mJ

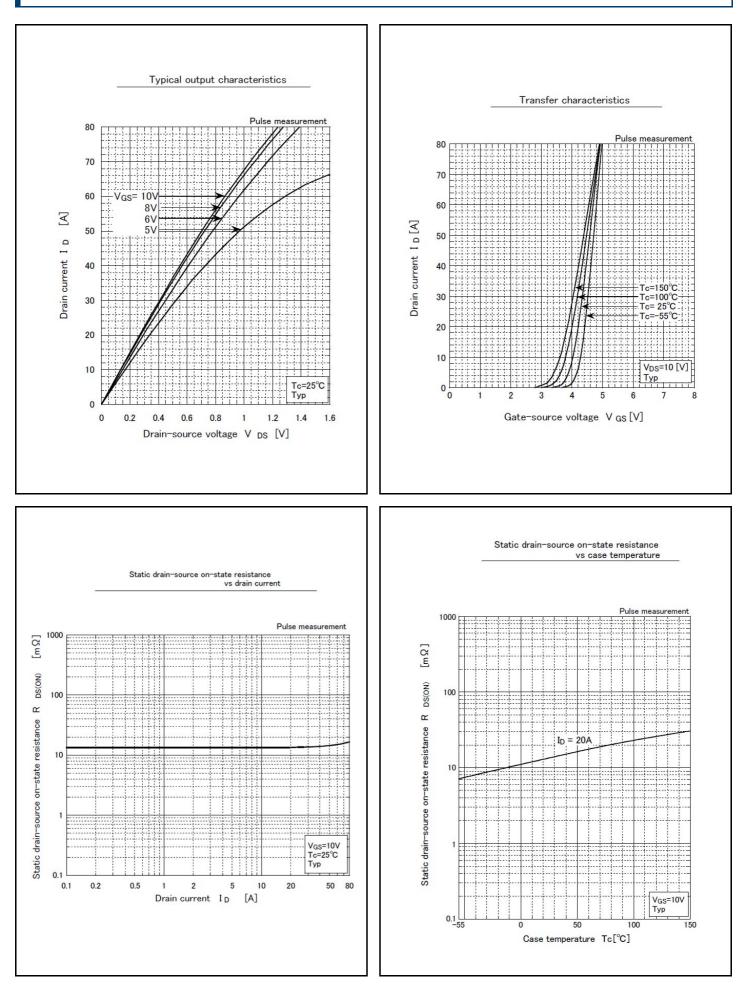
* : See the original Specifications

Electrical Characteristics	(unless otherwise specified : Tc=25°C)

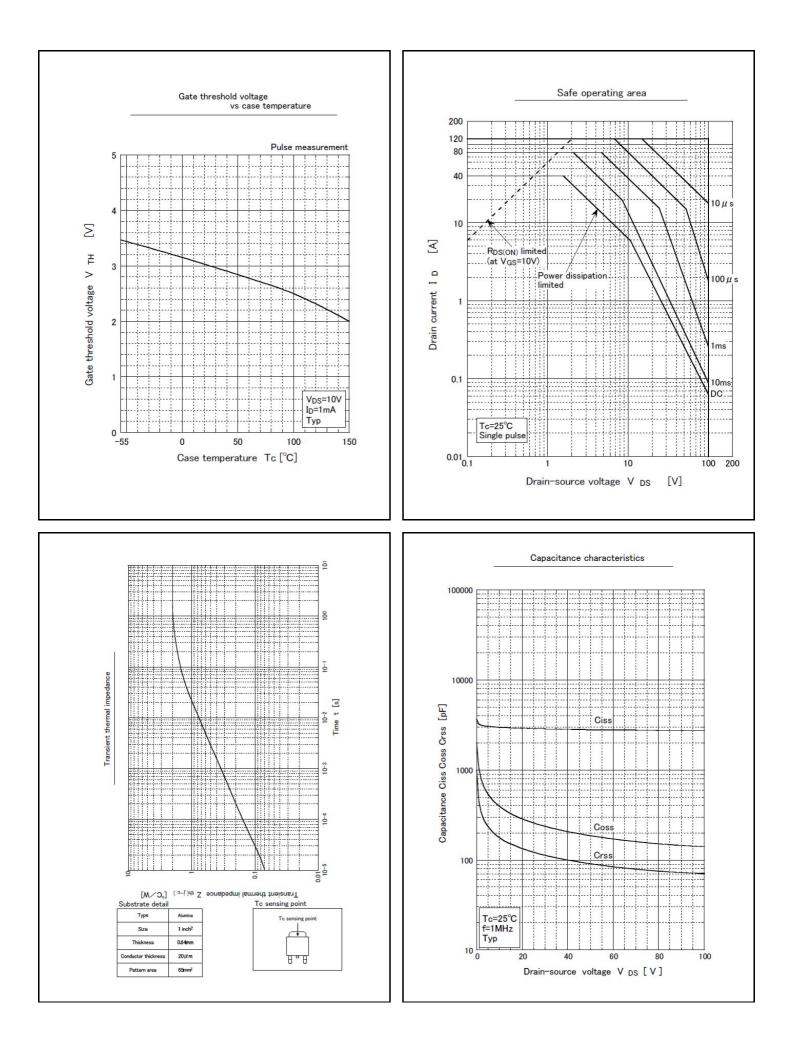
Item	Symbol	Conditions	Ratings			Unit
			MIN	ТҮР	MAX	Unit
Drain-Source breakdown voltage	V _{(BR)DSS}	ID=1mA, VGS=0V	100			V
Zero gate voltage drain current	I _{DSS}	VDS=100V, VGS=0V			1	μA
Gate-source leakage current	I _{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g fs	ID=20A, VDS=10V	12	24		S
Static drain-source on-state resistance	R _{DS(ON)}	ID=20A, VGS=10V		0.0134	0.0168	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	2	3	4	V
Source-drain diode forward voltage	V _{SD}	IS=40A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case, with heatsink *			2	°C/W
Total gate charge	Qg	VDD=80V, VGS=10V, ID=40A		56		nC
Gate to source charge	Qgs	VDD=80V, VGS=10V, ID=40A		15		nC
Gate to drain charge	Qgd	VDD=80V, VGS=10V, ID=40A		19.5		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		2880		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		122		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		258		pF
Turn-on delay time	td(on)	ID=20A, RL=2.5Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		7		ns
Rise time	tr	ID=20A, RL=2.5Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		17		ns
Turn-off delay time	td(off)	ID=20A, RL=2.5Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		31		ns
Fall time	tf	ID=20A, RL=2.5Ω, VDD=50V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		14		ns
Diode reverse recovery time	trr	IF=40A, VGS=0V, di/dt=100A/µs		54		ns
Diode reverse recovery charge	Qrr	IF=40A, VGS=0V, di/dt=100A/µs		108		nC

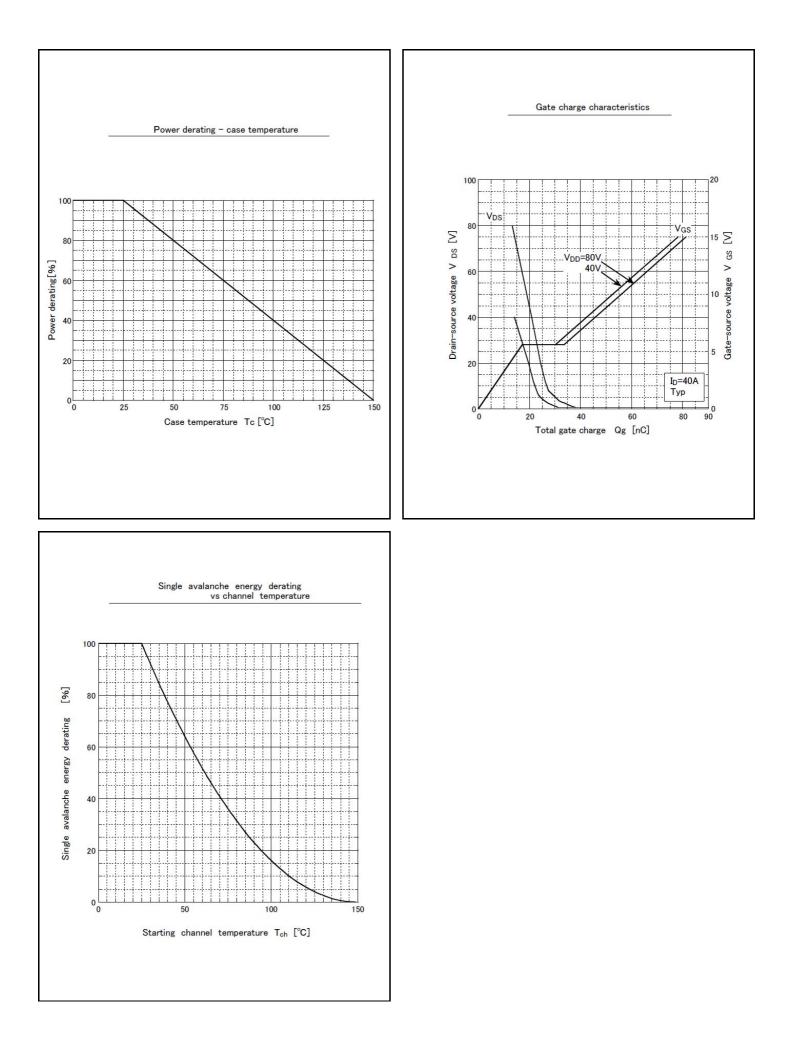
* : See the original Specifications

CHARACTERISTIC DIAGRAMS



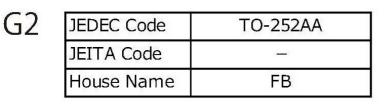
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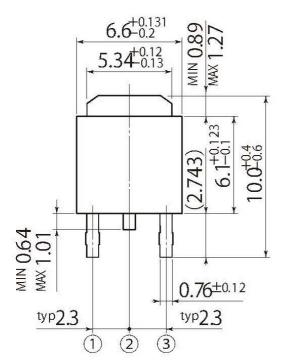


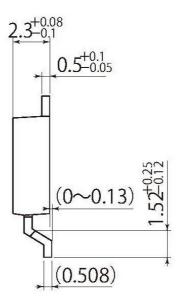


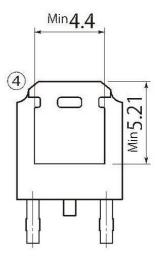
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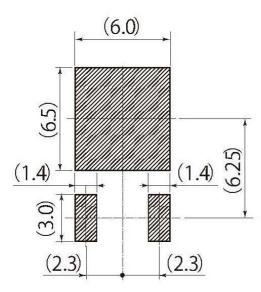
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Referential Soldering Pad

• Optimize soldering pad to the board design and soldering condition.

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